

COS/MOS INTEGRATED CIRCUIT

7929237 0014906 4
S G S-THOMSON 07C D

7-43-21

HCC/HCF 4093 B

41C 08920 D

7929225 S G S SEMICONDUCTOR CORP

QUAD 2-INPUT NAND SCHMITT TRIGGERS

- SCHMITT-TRIGGER ACTION ON EACH INPUT WITH NO EXTERNAL COMPONENTS
- HYSTERESIS VOLTAGE TYPICALLY 0.9V AT $V_{DD}=5V$ AND 2.3V AT $V_{DD}=10V$
- NOISE IMMUNITY GREATER THAN 50% OF V_{DD} (TYP.)
- NO LIMIT ON INPUT RISE AND FALL TIMES
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- QUIESCENT CURRENT SPECIFIED TO 20V FOR HCC DEVICE
- 5V, 10V, AND 15V PARAMETRIC RATINGS
- INPUT CURRENT OF 100 nA AT 18V AND 25°C FOR HCC DEVICE
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC TENTATIVE STANDARD No. 13A, "STANDARD SPECIFICATIONS FOR DESCRIPTION OF "B" SERIES CMOS DEVICES"

The **HCC 4093B** (extended temperature range) and **HCF 4093B** (intermediate temperature range) are available in 14-lead dual in-line plastic or ceramic package, ceramic flat package and plastic micropackage. The **HCC/HCF 4093B** consists of four Schmitt-trigger circuits. Each circuit functions as a two-input NAND gate with Schmitt-trigger action on both inputs. The gate switches at different points for positive and negative-going signals.

The difference between the positive voltage (V_P) and the negative voltage (V_N) is defined as hysteresis voltage (V_H) (See Fig. 1).

ABSOLUTE MAXIMUM RATINGS

V_{DD}^*	Supply voltage: HCC types HCF types	-0.5 to 20 -0.5 to 18	V V
V_i	Input voltage	-0.5 to $V_{DD} + 0.5$	V
I_i	DC input current (any one input)	± 10	mA
P_{tot}	Total power dissipation (per package)	200	mW
	Dissipation per output transistor for T_{op} = full package-temperature range	100	mW
T_{op}	Operating temperature: HCC types HCF types	-55 to 125 -40 to 85	°C °C
T_{stg}	Storage temperature	-65 to 150	°C

* All voltage values are referred to V_{SS} pin voltage

ORDERING NUMBERS:

HCC 4093 BD for dual in-line ceramic package
HCC 4093 BF for dual in-line ceramic package, frit seal
HCC 4093 BK for ceramic flat package
HCF 4093 BE for dual in-line plastic package
HCF 4093 BF for dual in-line ceramic package, frit seal
HCF 4093 BM for plastic micropackage

MECHANICAL DATA (dimensions in mm)

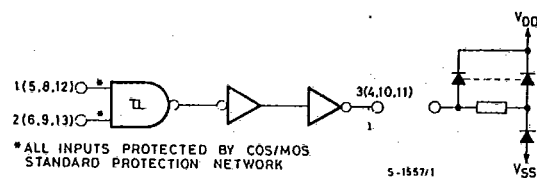
Technical drawings of the 4093 BD chip. The top view shows a rectangular package with dimensions 19.24 mm (length) and 7.36 mm (width). Pin 1 is at the top left, and pin 16 is at the bottom right. The side view shows a height of 3.3 mm and a width of 7.62 mm. The chip is labeled '4093 BD'.

Technical drawing of the ACC/HCF 4093 BF component. The drawing includes three views: a top view, a side view, and a bottom view. The top view shows a rectangular component with a width of 7 mm and a length of 15.24 mm. The side view shows a component with a height of 3.3 mm and a width of 9.52 mm. The bottom view shows a component with a width of 7 mm and a length of 15.24 mm. The component has a central slot and four mounting holes. The dimensions are given in millimeters (mm).

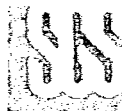
Technical drawing of a component with dimensions: 6.7, 6.9, 6.7mm, 1.27, 7.62, 0.3, 1.59, 0.38, 4.31, 0.127.



Technical drawings of the 1000 Series 1/2" components. The top drawing shows a side view of a component with dimensions: 0.25"±, 69-57, 0.7, 1.77"±, 1.20"±, 0.4, 762, 127, and 10.95"±. The bottom drawing shows a top view of a component with dimensions: 127"±, 4.0"±, and 10.95"±.



V_{DD}	Supply voltage: HCC types	3 to 18	V
	HCF types	3 to 15	V
V_I	Input voltage	0 to V_{DD}	V
T_{op}	Operating temperature: HCC types	-55 to 125	°C
	HCF types	-40 to 85	°C



HCC/HCF 4093B

41C 08922

D 7-43-21

7929225 S G S SEMICONDUCTOR CORP

STATIC ELECTRICAL CHARACTERISTICS (over recommended operating conditions)

Parameter			Test conditions				Values						Unit	
			V _I (V)	V _O (V)	I _O (μA)	V _{DD} (V)	T _{Low} *		25°C			T _{High} *		
							Min.	Max.	Min.	Typ.	Max.	Min.		Max.
I _L	Quiescent current	HCC types	0/ 5			5		1		0.02	1		30	μA
			0/10			10		2		0.02	2		60	
			0/15			15		4		0.02	4		120	
			0/20			20		20		0.04	20		600	
		HCF types	0/ 5			5		4		0.02	4		30	
			0/10			10		8		0.02	8		60	
			0/15			15		16		0.02	16		120	
V _P	Positive trigger threshold voltage	a			5	2.2	3.6	2.2	2.9	3.6	2.2	3.6	V	
		a			10	4.6	7.1	4.6	5.9	7.1	4.6	7.1		
		a			15	6.8	10.8	6.8	8.8	10.8	6.8	10.8		
		b			5	2.6	4	2.6	3.3	4	2.6	4		
		b			10	5.6	8.2	5.6	7	8.2	5.6	8.2		
		b			15	6.3	12.7	6.3	9.4	12.7	6.3	12.7		
V _N	Negative trigger threshold voltage	a			5	0.9	2.8	0.9	1.9	2.8	0.9	2.8	V	
		a			10	2.5	5.2	2.5	3.9	5.2	2.5	5.2		
		a			15	4	7.4	4	5.8	7.4	4	7.4		
		b			5	1.4	3.2	1.4	2.3	3.2	1.4	3.2		
		b			10	3.4	6.6	3.4	5.1	6.6	3.4	6.6		
		b			15	4.8	9.6	4.8	7.3	9.6	4.8	9.6		
V _H	Hysteresis voltage	a			5	0.3	1.6	0.3	0.9	1.6	0.3	1.6	V	
		a			10	1.2	3.4	1.2	2.3	3.4	1.2	3.4		
		a			15	1.6	5	1.6	3.5	5	1.6	5		
		b			5	0.3	1.6	0.3	0.9	1.6	0.3	1.6		
		b			10	1.2	3.4	1.2	2.3	3.4	1.2	3.4		
		b			15	1.6	5	1.6	3.5	5	1.6	5		
V _{OH}	Output high voltage	0/ 5		< 1	5	495		495			495		V	
		0/10		< 1	10	995		995			995			
		0/15		< 1	15	1495		1495			1495			
V _{OL}	Output low voltage	5/0		< 1	5		0.05			0.05		0.05	V	
		10/0		< 1	10		0.05			0.05		0.05		
		15/0		< 1	15		0.05			0.05		0.05		
I _{OH}	Output drive current	HCC types	0/ 5	2.5		5	-2		-1.6	-3.2		-1.15		mA
			0/ 5	4.6		5	-0.64		-0.51	-1		-0.36		
			0/10	9.5		10	-1.6		-1.3	-2.6		-0.9		
			0/15	13.5		15	-4.2		-3.4	-6.8		-2.4		
	HCF types	0/ 5	2.5		5	-1.53		-1.36	-3.2		-1.1			
		0/ 5	4.6		5	-0.52		-0.44	-1		-0.36			
		0/10	9.5		10	-1.3		-1.1	-2.6		-0.9			
		0/15	13.5		15	-3.6		-3.0	-6.8		-2.4			

a : input on terminals 1, 5, 8, 12 or 2, 6, 9, 13; other inputs to V_{DD}.b : input on terminals 1 and 2, 5 and 6, 8 and 9, or 12 and 13; other inputs to V_{DD}.

HCC/HCF 4093B

7929225 S G S SEMICONDUCTOR CORP 41C 08923 D

STATIC ELECTRICAL CHARACTERISTICS (continued)

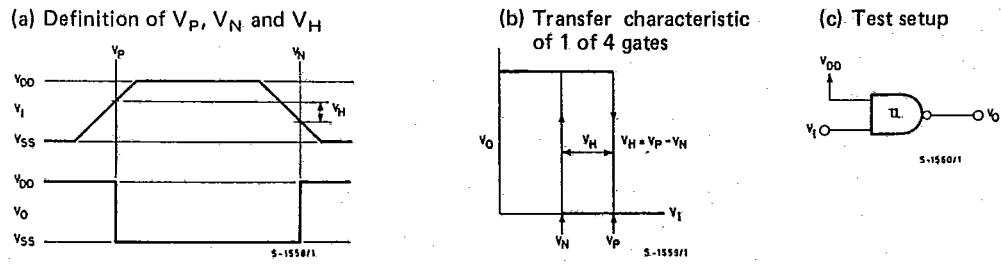
Parameter		Test conditions				Values						Unit	
		V _I (V)	V _O (V)	I _O (μA)	V _{DD} (V)	T _{Low} *		25°C			T _{High} *		
						Min.	Max.	Min.	Typ.	Max.	Min.		Max.
I _{OL}	Output sink current	0/ 5	0.4		5	0.64		0.51	1		0.36		mA
		0/10	0.5		10	1.6		1.3	2.6		0.9		
		0/15	1.5		15	4.2		3.4	6.8		2.4		
		0/ 5	0.4		5	0.52		0.44	1		0.36		
		0/10	0.5		10	1.3		1.1	2.6		0.9		
		0/15	1.5		15	3.6		3.0	6.8		2.4		
I _{IH} , I _{IL}	Input leakage current	HCC types HCF types	0/18	Any input	18		±0.1		±10 ⁻⁵	±0.1		± 1	μA
			0/15		15		±0.3		±10 ⁻⁵	±0.3		± 1	
C _I	Input capacitance		Any input					5	7.5			pF	

* T_{Low} = - 55°C for HCC device; -40°C for HCF device.
* T_{High} = +125°C for HCC device; +85°C for HCF device.

DYNAMIC ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C, C_L = 50 pF, R_L = 200 kΩ,
typical temperature coefficient for all V_{DD} = 0.3%/°C values, all input rise and fall time = 20 ns)

Parameter	Test conditions	Values			Unit	
		V _{DD} (V)	Min.	Typ.		Max.
t _{PLH} , Propagation delay time t _{PHL}		5		190	380	ns
		10		90	180	
		15		65	130	
t _{TLH} , Transition time t _{THL}		5		100	200	ns
		10		50	100	
		15		40	80	

Fig. 1 - Hysteresis definition, characteristic and test setup





41C 08924 D

7929225 S G S SEMICONDUCTOR CORP

Fig. 2 - Input and output characteristics

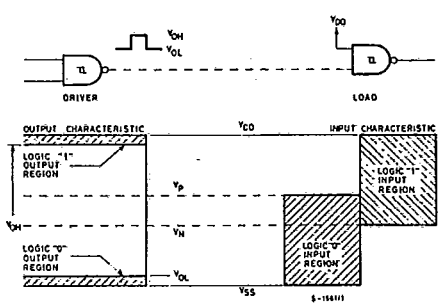


Fig. 3 - Typical current and voltage transfer characteristics

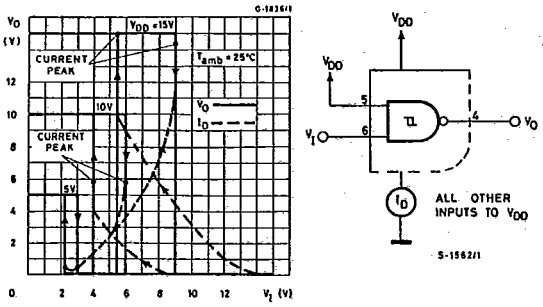


Fig. 4 - Typical voltage transfer characteristics as a function of temperature, and test circuit

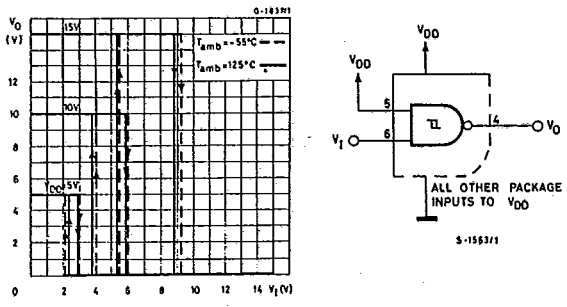


Fig. 5 - Typical output low (sink) current characteristics

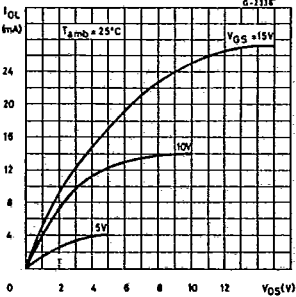


Fig. 6 - Minimum output low (sink) current characteristics

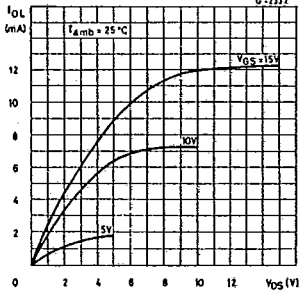


Fig. 7 - Typical output high (source) current characteristics

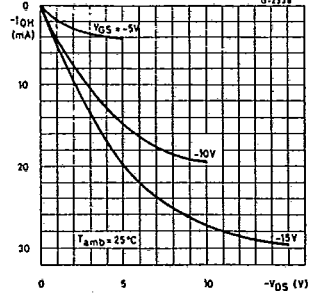
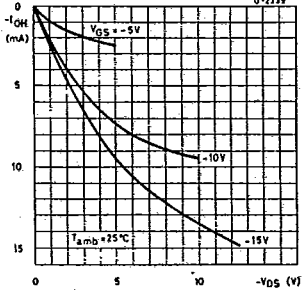


Fig. 8 - Minimum output high (source) current characteristics



HCC/HCF 4093B

7929225 S G S SEMICONDUCTOR CORP 41C 08925 D

Fig. 9 - Typical propagation delay time vs. supply voltage

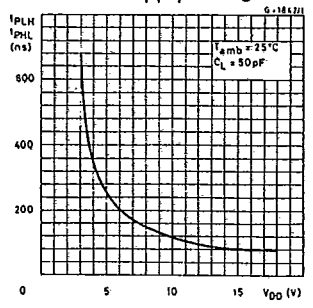


Fig. 10 - Typical transition time vs. load capacitance

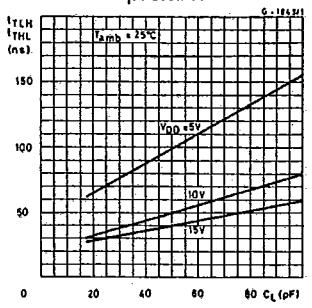


Fig. 11 - Typical trigger threshold voltage vs. V_{DD}

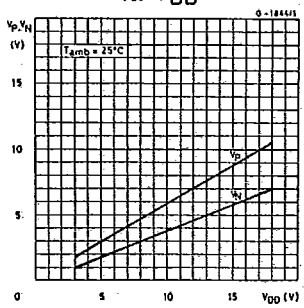


Fig. 12 - Typical per cent hysteresis vs. supply voltage

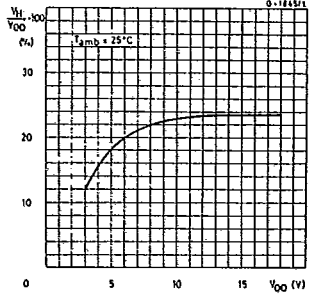


Fig. 13 - Typical dissipation characteristics

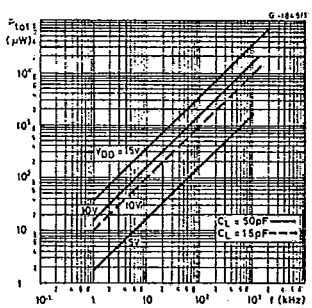
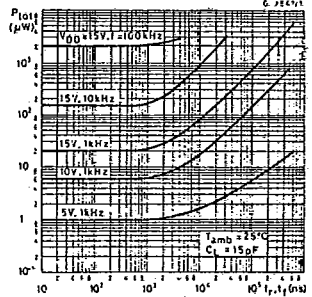


Fig. 14 - Power dissipation vs. rise and fall times



APPLICATIONS

Fig. 15 - Wave shaper

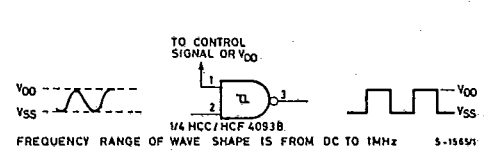
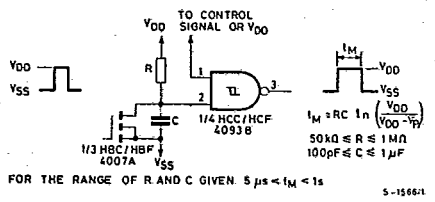


Fig. 16 - Monostable multivibrator



7929225 S G S SEMICONDUCTOR CORP
APPLICATIONS (continued)

TO CONTROL SIGNAL OR V_{DD}

1/4 HCC/HCF 4093 B

1

2

3

4

V_{DD}

V_{SS}

R

C

t_A

$t_A \approx 2RC \ln \left[\left(\frac{V_P}{V_N} \right) \left(\frac{V_{DD} - V_N}{V_{DD} - V_P} \right) \right]$

$50\text{ k}\Omega \leq R \leq 1\text{ M}\Omega$

$100\text{ pF} \leq C \leq 1\text{ }\mu\text{F}$

FOR THE RANGE OF R AND C GIVEN $2\text{ }\mu\text{s} < t_A < 0.4\text{ s}$

S-1567/1

Fig. 18 – Quiescent device current

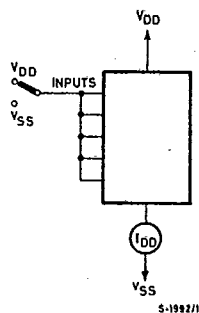
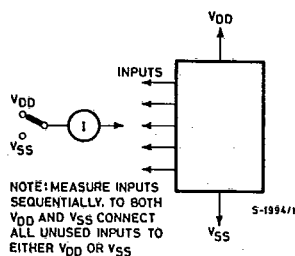
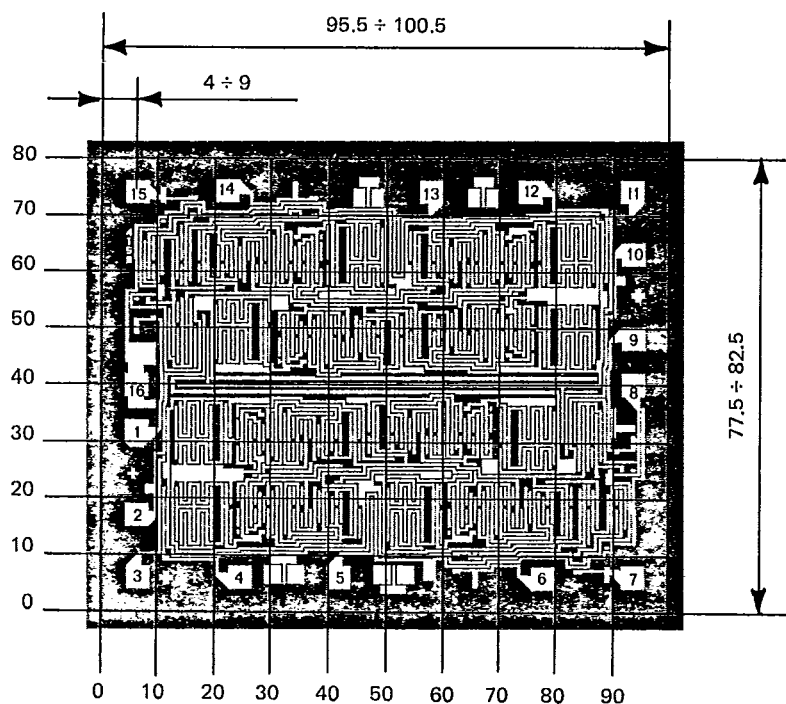
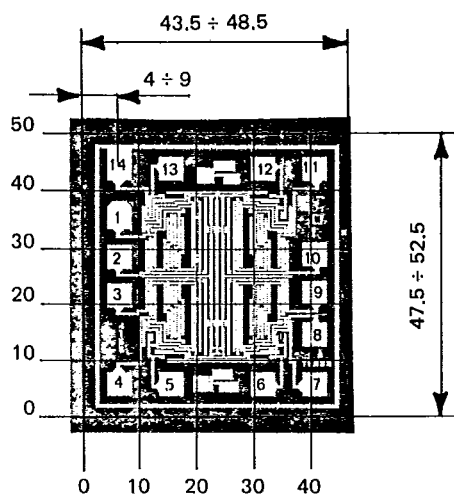


Fig. 19 – Input leakage current





4015B



4016B